

TOSHIBA Zener Diode Silicon Diffused Type

CMZB12~CMZB53

- Communication, Control and Measurement Equipment
- Constant Voltage Regulation
- Transient Suppressors

- Average power dissipation: P = 1.0 W
- Zener voltage: V_Z = 12 to 53 V
- Suitable for high-density board assembly due to the use of a small surface-mount package, M-FLAT™

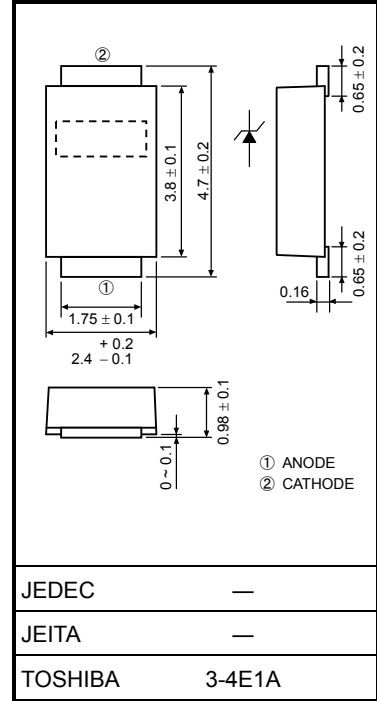
Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	P	1.0 (Note 1)	W
Junction temperature	T _j	-40 to 150	°C
Storage temperature range	T _{stg}	-40 to 150	°C

Note 1: Ta = 40°C
 Device mounted on a glass-epoxy board
 Board size: 50 mm × 50 mm
 Soldering size: 6 mm × 6 mm
 Board thickness: 1.6 mm

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature / current / voltage, etc.) are within the absolute maximum ratings.
 Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Unit: mm



Weight: 0.023 g (typ.)

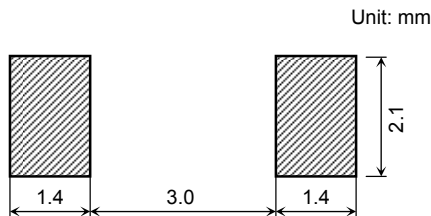
Electrical Characteristics (Ta = 25°C)

Type	Zener Voltage Vz (V)				Zener Impedance rd (Ω)		Temperature Coefficient Of Zener αT (mV/°C)		Forward Voltage VF (V)		Reverse Current IR (μA)	
	Min	Typ.	Max	Measurement Current Iz (mA)	Max	Measurement Current Iz (mA)	Typ.	Max	Max	Measurement Current IF (A)	Max	Measurement Voltage VR (V)
CMZB12	10.8	12	13.2	10	30	10	8	13	1.2	0.2	10	8
CMZB13	11.7	13	14.3	10	30	10	9	14	1.2	0.2	10	9
CMZB15	13.5	15	16.5	10	30	10	11	17	1.2	0.2	10	10
CMZB16	14.4	16	17.6	10	30	10	12	19	1.2	0.2	10	11
CMZB18	16.2	18	19.8	10	30	10	14	23	1.2	0.2	10	13
CMZB20	18.0	20	22.0	10	30	10	16	26	1.2	0.2	10	14
CMZB22	19.8	22	24.2	10	30	10	18	28	1.2	0.2	10	16
CMZB24	21.6	24	26.4	10	30	10	20	32	1.2	0.2	10	17
CMZB27	24.3	27	29.7	10	30	10	23	36	1.2	0.2	10	19
CMZB30	27.0	30	33.0	10	30	10	25	40	1.2	0.2	10	21
CMZB33	29.7	33	36.3	10	30	10	26	41	1.2	0.2	10	26.4
CMZB36	32.4	36	39.6	9	30	9	28	45	1.2	0.2	10	28.8
CMZB39	35.1	39	42.9	8	35	8	30	48	1.2	0.2	10	31.2
CMZB43	38.7	43	47.3	7	40	7	33	53	1.2	0.2	10	34.4
CMZB47	42.3	47	51.7	6	65	6	38	60	1.2	0.2	10	37.6
CMZB51	45.9	51	56.1	6	65	6	43	68	1.2	0.2	10	40.8
CMZB53	47.7	53	58.3	5	85	5	49	77	1.2	0.2	10	42.4

Marking

Abbreviation Code	Part No.	Abbreviation Code	Part No.
B12	CMZB12	B30	CMZB30
B13	CMZB13	B33	CMZB33
B15	CMZB15	B36	CMZB36
B16	CMZB16	B39	CMZB39
B18	CMZB18	B43	CMZB43
B20	CMZB20	B47	CMZB47
B22	CMZB22	B51	CMZB51
B24	CMZB24	B53	CMZB53
B27	CMZB27		

Standard Soldering Pad

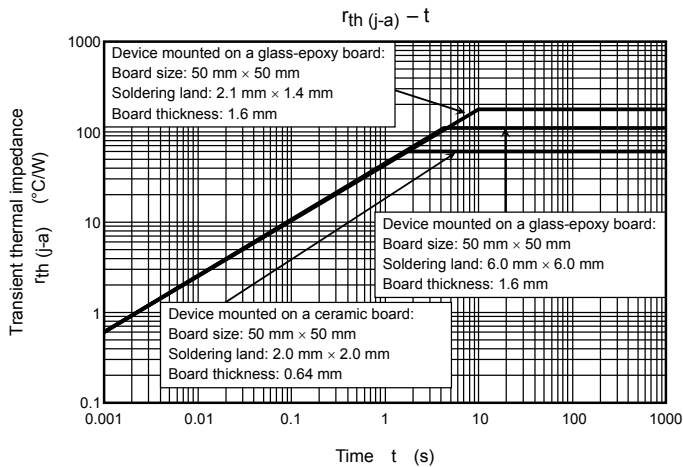
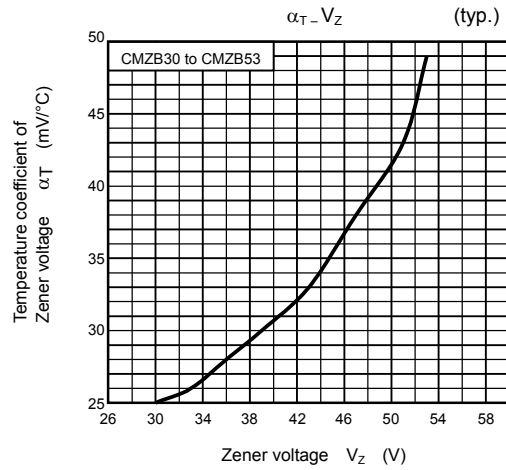
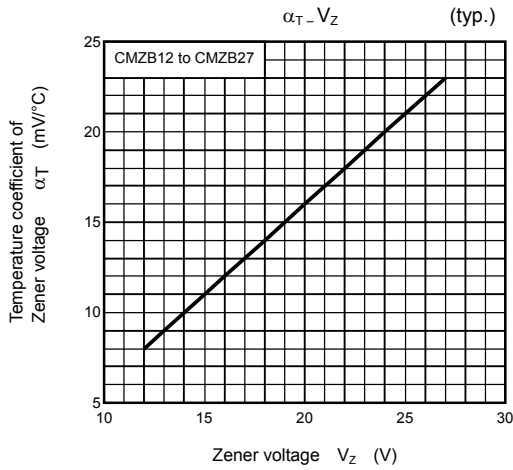
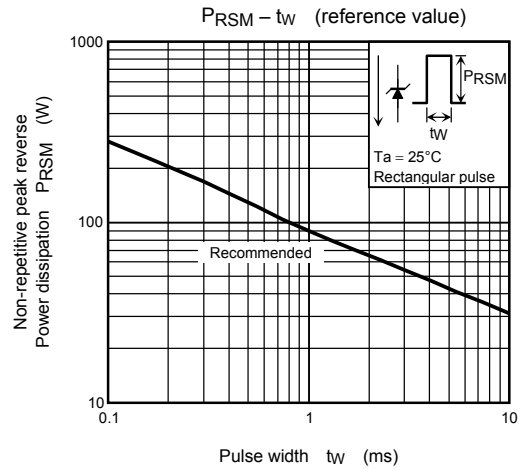
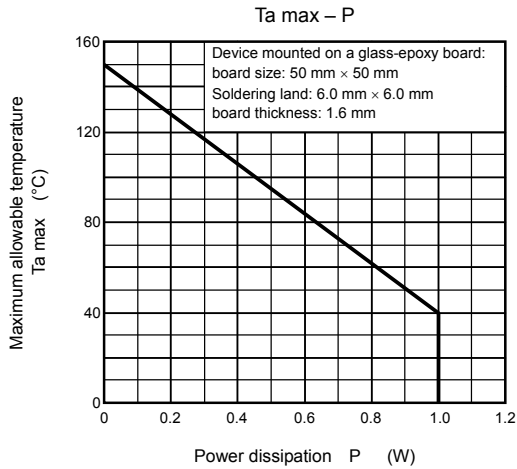


Handling Precaution

- 1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. The following are the general derating methods that we recommend when you design a circuit with a device.

- P: We recommend that the worst case power dissipation be no greater than 50% of the absolute maximum rating of power dissipation. Carry out adequate heat design.
- PRSM: We recommend that a device be used within the recommended area in the figure, $PRSM \cdot tw$.
- T_j : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at T_j of below 120°C.

- 2) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 3) Please refer to the Rectifiers databook for further information.



RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
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